

# **IPD Protect**

# IGBT 20A/1350V RC-H5 technology with driver IC

#### Features

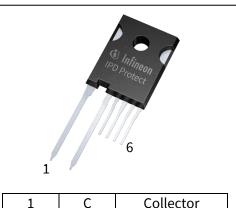
- Reverse conducting IGBT with monolithic body diode designed for soft commutation
- Integrated Driver with
  - o Over-voltage and over-current protection
  - Active clamp control circuit
  - Programmable over-voltage threshold
  - Programmable cycle-by-cycle over-current threshold
  - Integrated gate drive with 2 level turn-on current
  - Temperature warning
  - Over-temperature protection
  - VCC UVLO
  - Integrated ESD protection and latch immunity on all pins
- Qualified forindustrial applications according to the relevant tests of JEDEC47/20/22
- PG-TO247-6 package
- http://www.infineon.com/IPD-Protect

## Applications

• Induction cooking

## Description

The IPD (Integrated Power Device) Protect includes an IGBT with Gate Driver IC in a TO247 6-pin package for induction cooking applications. Its innovative concepts provide protection against over-voltage, over-current, and over-temperature. Additional features include a unique active clamp control, fault condition notification, and a special two levels turn-on Gate driving that reduces significantly the typical high startup peak current. These integrated protection functions provide a simple and robust solution with increased overall system reliability.

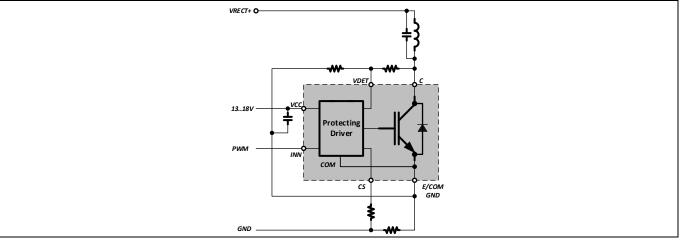


| 1 | С     | Collector      |
|---|-------|----------------|
| 2 | E/COM | Emitter/Ground |
| 3 | VCC   | Supply         |
| 4 | CS    | Current Sense  |
| 5 | INN   | PWM Input      |
| 6 | VDET  | Voltage Sense  |
|   |       |                |



#### IEWS20R5135IPB IGBT 20A/1350V RC-H5 technology with driver IC Table of Contents





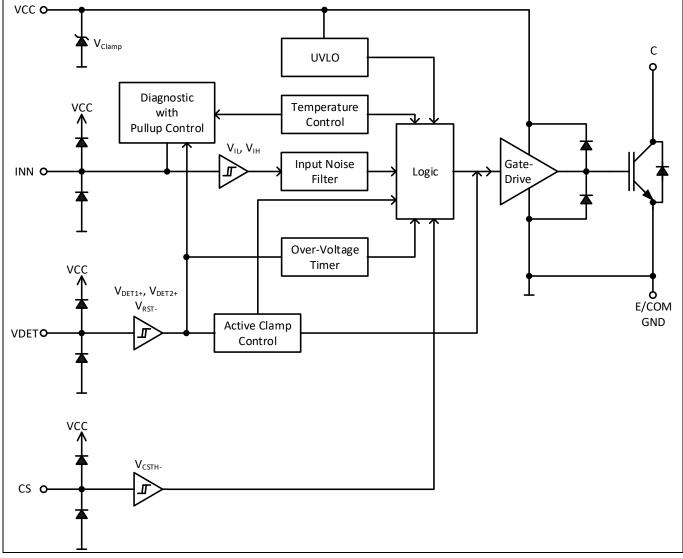


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# 1 Block Diagram





IPD Protect IGBT 20A/1350V RC-H5 technology with driver IC State Diagram



# 2 State Diagram

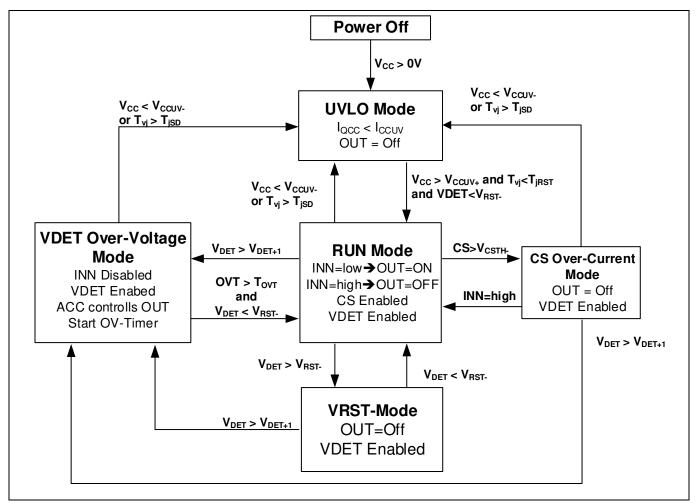


Figure 3 State diagram of IEWS20R5135IPB



# 3 Electrical Parameters Driver

# 3.1 Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any pin.

|                      |                  | ings |                                 |      |  |
|----------------------|------------------|------|---------------------------------|------|--|
| Parameter            | Symbol           | Min. | Max.                            | Unit | Test Conditions                          |
| VDET pin voltage     | V <sub>DET</sub> |      |                                 |      |  |
| VCC pin voltage      | Vcc              | -0.3 | V <sub>CLAMP</sub> <sup>1</sup> | V    |  |
| CS pin voltage       | Cs               |      |                                 |      |  |
| INN pin voltage      | I <sub>NN</sub>  | -0.3 | 5                               | V    |  |
| Junction temperature | T <sub>vj</sub>  | 40   | 150                             | °C   |  |
| Storage temperature  | Ts               | -40  | 150                             | C    |  |
| ESD capability       | V <sub>ESD</sub> |      | 750                             | V    | Charged Devices Model (CDM) <sup>2</sup> |
| ESD capability       | V <sub>ESD</sub> |      | 2.0                             | KV   | Human Body Model (HBM) <sup>3</sup>      |

#### Table 1 Absolute Maximum Ratings

# 3.2 Recommended Operating Conditions

For proper operation the device should be used within the recommended conditions. ( $T_A=25^{\circ}C$ )

#### Table 2 Recommended Operating Conditions

| Parameter            | Symbol           | Min. | Max. | Unit |
|----------------------|------------------|------|------|------|
| VDET pin voltage     | V <sub>DET</sub> |      |      |      |
| VCC pin voltage      | V <sub>cc</sub>  | -0.3 | 20   | V    |
| CS pin voltage       | Cs               |      |      |      |
| INN pin voltage      | I <sub>NN</sub>  | -0.3 | 5    | V    |
| Junction temperature | T <sub>vj</sub>  | -40  | 125  | °C   |

<sup>2</sup>According to the JESD22-C101 CDM standard

 $^{\rm 3}\mbox{According}$  to the JESD22-A114 Rev. F standard

<sup>&</sup>lt;sup>1</sup>This IC contains a 25V voltage clamp structure between the VCC and COM pins. Please note that this pin should not be driven by a DC, low impedance power source greater than the V<sub>CLAMP</sub> specified in the Electrical Characteristics section.



## 3.3 Electrical Characteristics

 $V_{CC}$ =15.0V,  $T_A$  = 25 °C unless otherwise specified. All parameters are referenced to COM.

#### Table 3 VCC Characteristics

| Parameter                                    | Symbol             | Min. | Тур. | Max. | Unit | <b>Test Conditions</b>                    |
|--|--------------------|------|------|------|------|---|
| V <sub>cc</sub> rising UVLO threshold        | V <sub>CCUV+</sub> | 13.0 | 13.5 | 14.0 | V    |   |
| V <sub>cc</sub> falling UVLO threshold       | V <sub>CCUV-</sub> | 12.0 | 12.5 | 13.0 | V    |   |
| V <sub>cc</sub> supply current during UVLO   | I <sub>ccuv</sub>  |      | 200  |      |      | V <sub>cc</sub> =V <sub>ccuv-</sub> -0.5V |
| V <sub>cc</sub> quiescent supply current     | I <sub>QCC</sub>   |      | 3000 |      | μA   |   |
| V <sub>cc</sub> internal Zener clamp voltage | V <sub>CLAMP</sub> |      | 25   |      | V    | I <sub>cc</sub> =5mA                      |

#### Table 4CS Characteristics

| Parameter                                  | Symbol             | Min. | Тур. | Max. | Unit | <b>Test Conditions</b> |
|--|--------------------|------|------|------|------|------------------------|
| Over-current threshold voltage             | V <sub>CSTH-</sub> | -5%  | -0.2 | +5%  | V    |                        |
| Over-current detection internal blank time | t <sub>csblk</sub> | 3.5  |      | 4.5  | μs   |                        |
| Over-current detection propagation delay   | t <sub>cs</sub>    |      | 50   |      | ns   |                        |

#### Table 5 VDET Characteristics

| Parameter                                  | Symbol               | Min. | Тур. | Max. | Unit | <b>Test Conditions</b> |
|--|----------------------|------|------|------|------|------------------------|
| Over-voltage rising threshold voltage 1    | V <sub>DET+1</sub>   | -3%  | 3.91 | +3%  |      |                        |
| Over-voltage rising threshold voltage 2    | V <sub>DET+2</sub>   | -3%  | 4.36 | +3%  | V    | Figure 8               |
| Restart falling threshold voltage          | V <sub>rst-</sub>    | -3%  | 1.37 | +3%  |      | +<br>Figure 9          |
| Over-voltage clamping time 1               | t <sub>clamp1</sub>  | 4.25 | 5.0  | 5.75 | μs   | rigure 5               |
| Over-voltage blank timer                   | t <sub>ovt</sub>     | 3    |      |      | ms   |                        |
| Over-voltage blanking time @ turn-off IGBT | t <sub>vdetblk</sub> |      | 1200 |      | ns   |                        |

#### Table 6 Temperature Warning / Shutdown

| Parameter                             | Symbol             | Min. | Тур. | Max. | Unit | <b>Test Conditions</b> |
|---------------------------------------|--------------------|------|------|------|------|------------------------|
| Junction temperature warning          | $T_{vjTW}$         |      | 75   |      |      |                        |
| Junction temperature thermal shutdown | $T_{vjSD}$         |      | 150  |      | °C   |                        |
| Junction temperature thermal reset    | T <sub>vjRST</sub> |      | 75   |      |      |                        |

#### IPD Protect IGBT 20A/1350V RC-H5 technology with driver IC Electrical Parameters Driver



#### Table 7 INN / OUT Characteristics

| Parameter   | Symbol                 | Min. | Тур  | Max. | Unit | <b>Test Conditions</b> |
|---|------------------------|------|------|------|------|------------------------|
| Logic "0" input voltage (OUT = HI)                          | VIL                    |      |      | 0.8  |      | Figure 6               |
| Logic "1" input voltage (OUT = LO)                          | V <sub>IH</sub>        | 2.0  |      |      |      | Figure C               |
| INN pullup-voltage ➔ no fault                               | V <sub>IPUnf</sub>     | 2.10 | 2.50 | 2.90 | v    |                        |
| INN pullup-voltage → temp warning                           | V <sub>IPUtw</sub>     | 4.00 | 4.50 | 5.00 | v    |                        |
| INN voltage → over-voltage detection or over-temp shut-down | VIPUov                 |      |      | 0.5  |      |                        |
| Turn-on filter time   | t <sub>ONfilter</sub>  | 340  | 400  | 460  |      |                        |
| Turn-off filter time  | t <sub>OFFfilter</sub> | 1275 | 1700 | 2200 | ns   |                        |
| Logic "0" input bias current                                | I <sub>IN-</sub>       |      | -500 |      | μA   | V <sub>NN</sub> =0V    |



# 4 Electrical Parameters IGBT

#### 4.1 Absolute Maximum Ratings

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in the datasheet.

| Table 8 | <b>Absolute Maximum Ratings</b> |
|---------|---------------------------------|
|         |                                 |

| Parameter  | Symbol             | Value   | Unit |
|--|--------------------|---------|------|
| Collector-emitter voltage, T <sub>vj</sub> ≥25°C                                     | V <sub>CE</sub>    | 1350    | V    |
| DC collector current, limited by $T_{vjmax}$   |                    |         |      |
| $T_{\rm C} = 25^{\circ}{\rm C}$  | Ι <sub>c</sub>     | 40.0    | А    |
| $T_{\rm C} = 100^{\circ}{\rm C}$   |                    | 20.0    |      |
| Pulsed collector current, $t_p$ limited by $T_{vjmax}$                               | I <sub>Cpuls</sub> | 60      | А    |
| Turn off safe operating area (V_{CE} \le 1350V, T_{vj} \le 175^{\circ}C, t_p=1\mu s) | -                  | 60      | А    |
| Diode forward current, limited by <i>T</i> <sub>vjmax</sub>                          |                    |         |      |
| $T_{\rm C} = 25^{\circ}{\rm C}$  | I <sub>F</sub>     | 40.0    | А    |
| $T_{\rm C} = 100^{\circ}{\rm C}$   |                    | 20.0    |      |
| Diode pulsed current, $t_p$ limited by $T_{vjmax}$                                   | l <sub>Fpuls</sub> | 60.0    | А    |
| Gate-emitter voltage   | M                  | ±20     | v    |
| Transient Gate-emitter voltage (tp≤10µs, D<0.010)                                    | Vge                | ±25     | V    |
| Power dissipation $T_c = 25^{\circ}C$  | P                  | 288.0   | 14/  |
| Power dissipation $T_c = 100^{\circ}C$   | P <sub>tot</sub>   | 144.0   | W    |
| Virtual junction temperature   | Τ <sub>νj</sub>    | -40+175 | °C   |
| Operating junction temperature <sup>1</sup>  | T <sub>vj,op</sub> | -40+150 | °C   |
| Storage temperature  | T <sub>stg</sub>   | -40+150 | °C   |
| Soldering temperature, 1.6mm (0.063 in.) from case for 10s                           | -                  | 260     | °C   |
| Mounting torque, M3 screw  | м                  | 0.6     | Nm   |
| Maximum of mounting processes: 3   | IVI                | 0.0     |      |
| ESD capability Charged Devices Model (CDM) <sup>2</sup>                              | V <sub>ESD</sub>   | 750     | V    |
| ESD capability Human Body Model (HBM) <sup>3</sup>                                   | V <sub>ESD</sub>   | 2.0     | KV   |

#### Table 9Thermal Resistance

| Parameter                                 | Symbol        | Value | Unit |
|---|---------------|-------|------|
| IGBT thermal resistance, junction – case  | $R_{th(j-c)}$ | 0.52  | K/W  |
| Diode thermal resistance, junction – case | $R_{th(j-c)}$ | 0.52  | K/W  |
| Thermal resistance, junction – ambient    | $R_{th(j-a)}$ | 40    | K/W  |

 $^{1}\mbox{Limited}$  by  $T_{\nu j,max}$  of the driver Ic.

<sup>&</sup>lt;sup>2</sup>According to the JESD22-C101 CDM standard

<sup>&</sup>lt;sup>3</sup>According to the JESD22-A114 Rev. F standard



## IPD Protect IGBT 20A/1350V RC-H5 technology with driver IC Electrical Parameters Driver

#### 4.2 Electrical Characteristics

At  $T_{vj}$ =25°C and V<sub>CC</sub>=15V, unless otherwise specified

#### Table 10Static Characteristic

| Parameter                            | Symbol               | Conditions                                      | Min. | Тур. | Max. | Unit |
|--------------------------------------|----------------------|---|------|------|------|------|
| Collector-emitter breakdown voltage  | V <sub>(BR)CES</sub> | I <sub>NN</sub> =open,<br>I <sub>c</sub> =0.5mA | 1350 | -    | -    |      |
| Collector-emitter saturation voltage |                      | $V_{IN} = 0V, I_{C} = 20A$                      |      |      |      |      |
|                                      |                      | T <sub>vj</sub> =25°C                           | -    | 1.65 | 1.85 |      |
|                                      | $V_{CE(sat)}$        | T <sub>vj</sub> =125°C                          | -    | 1.85 | -    |      |
|                                      |                      | $T_{vj}=150^{\circ}C$                           | -    | 1.90 | -    | V    |
| Diode forward voltage                |                      | I <sub>NN</sub> =open I <sub>F</sub> =20A       |      |      |      |      |
|                                      | N                    | T <sub>vj</sub> =25°C                           | -    | 1.71 | 1.90 |      |
|                                      | V <sub>F</sub>       | T <sub>vj</sub> =125°C                          | -    | 1.85 | -    |      |
|                                      |                      | $T_{vj}=150^{\circ}C$                           | -    | 1.97 | -    |      |
| Transconductance                     | g <sub>fs</sub>      | V <sub>CE</sub> =20V, I <sub>C</sub> =20A       | -    | 15.8 | -    | S    |

#### Table 11Switching Characteristics, Inductive Load at T<sub>vj</sub>=25°C

| Parameter                       | Symbol                | Conditions  | Min. | Тур. | Max. | Unit |
|---------------------------------|-----------------------|---|------|------|------|------|
| Turn-on propagation time        | t <sub>PD,on</sub>    | V <sub>DC</sub> =600V, I <sub>C</sub> =20.0A  | -    | 668  | -    | ns   |
| Turn-off propagation time       | $t_{PD,off}$          | I <sub>NN</sub> =open/0V  | -    | 2034 | -    | ns   |
| Fall time                       | t <sub>f</sub>        | $L_{\sigma}$ =175nH, $C_{\sigma}$ =40pF<br>$L_{\sigma}$ , $C_{\sigma}$ fromFig. F<br>Energy losses include<br>"tail". | -    | 83   | -    | ns   |
| Turn-off energy                 | E <sub>off</sub>      |   | -    | 1.2  | -    | mJ   |
| Turn-off energy, soft switching | E <sub>off,soft</sub> | dV <sub>CE</sub> /dt = 67V/ μs<br>From Fig. F<br>Energy losses include<br>"tail".                                     | -    | 0.26 | -    | mJ   |

#### IPD Protect IGBT 20A/1350V RC-H5 technology with driver IC Electrical Parameters Driver



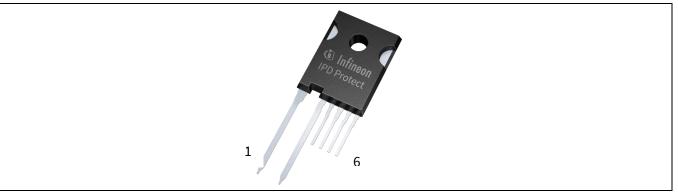
#### Table 12 Switching Characteristics, Inductive Load at T<sub>vj</sub>=150°C

| Parameter                       | Symbol                | Conditions  | Min. | Тур. | Max. | Unit |
|---------------------------------|-----------------------|---|------|------|------|------|
| Turn-on propagation time        | t <sub>PD,on</sub>    | V <sub>DC</sub> =600V, I <sub>C</sub> =20.0A                                      | -    | 705  | -    | ns   |
| Turn-off propagation time       | t <sub>PD,off</sub>   | I <sub>NN</sub> =open/0V  | -    | 2257 | -    | ns   |
| Fall time                       | t <sub>f</sub>        | $L_{\sigma}$ =175nH, $C_{\sigma}$ =40pF   | -    | 231  | -    | ns   |
| Turn-off energy                 | E <sub>off</sub>      | L <sub>o</sub> , C <sub>o</sub> fromFig. F<br>Energy losses include<br>"tail".    | -    | 2.2  | -    | mJ   |
| Turn-off energy, soft switching | E <sub>off,soft</sub> | dV <sub>cE</sub> /dt = 67V/ μs<br>From Fig. F<br>Energy losses include<br>"tail". | -    | 0.40 | -    | mJ   |



# 5 Pin Configuration, Description and Functionality

## 5.1 Pin Configuration and Description



#### Figure 4 Pin Configuration

| Table 13 | Pin Description |   |
|----------|-----------------|---|
| Pin      | Symbol          | Description                                       |
| 1        | С               | Collector of IGBT                                 |
| 2        | E/COM           | Emitter of IGBT, ground connection for the driver |
| 3        | VCC             | Supply-voltage of the driver                      |
| 4        | CS              | Current-limitation input                          |
| 5        | INN             | PWM input (low active) / Diagnostic output        |
| 6        | VDET            | Over-voltage dectection input                     |

#### 5.2 IGBT connect pins (C, E/COM)

A RC-H5 IGBT is integrated into the TO247-6pin package. The chip includes a powerful monolithic body diode for soft commutation. The TRENCHSTOP<sup>™</sup> technology offers

- Very tight parameter distribution
- High ruggedness and temperature stable behavior
- Low V<sub>CEsat</sub>
- Low EMI

#### 5.3 VCC and COM

VCC is the voltage supply for the logic and the driver output stage. All inputs and outputs are referenced to COM. The undervoltage lockout circuit enables the device to operate at power on when a typical supply voltage higher than V<sub>CCUV+</sub> is present. Please see section 3.3 "VCC Characteristics" for further information.



# 5.4 Current limitation input (CS)

The integrated cycle by cycle current limitation, given in the next figure, offers independent of the external control and input-voltage level, a voltage limitation across the IGBT. The negative current sense threshold ( $V_{CSTH-}$ ) has the big advantage that the current sense resistor is not in the gate-drive loop. When the INN-input is switched to COM, the IGBT is turned on from the driver and the current-sense input gets enabled after a delay of  $t_{CSBLK}$ , to avoid miss-triggering during NZVS (Non Zero Voltage Switching) conditions. Once enabled, the voltage at the CS-pin gets monitored and when the current sense threshold is reached the IGBT turns off immediately, independent from the signal at the INN-input. A resistor of 1kOhm should be placed in series to the CS input to limit currents through the internal ESD-diodes due to transients.

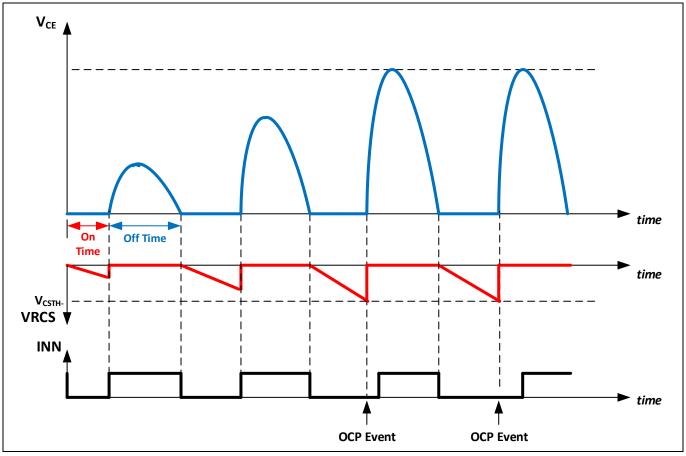


Figure 5 Cycle by cycle current limitation

# 5.5 PWM input / Diagnostic output (INN)

The INN pin is a multifunctional pin. It acts as an input to control the ON-time of the IGBT and during the OFF-time, the diagnostic block controls the pull-up voltage level according to the status (see Table 14 & Figure 8). To control the turn-on of the IGBT an open drain output should be connected to the INN pin. The Schmitt trigger input is such to guarantee compatibility down to 3.3V controller. The input Schmitt trigger and noise filter provide beneficial noise rejection to short input pulses according to Figure 6 and Figure 10.



#### Pin Configuration, Description and Functionality

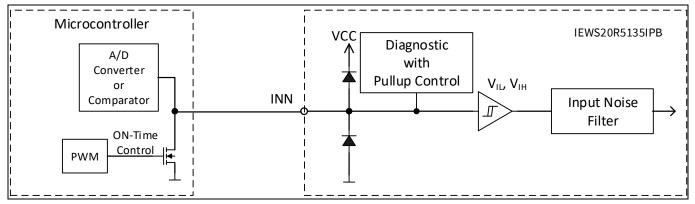


Figure 6 INN internal structure

#### Table 14 INN Diagnostic Pullup-Levels

| Status       | Pull-up Level (INN) |
|--------------|---------------------|
| UVLO         | <0,5V               |
| No Fault     | 2,10V – 2,90V       |
| OT-Warning   | 4V – 5V             |
| OV-Detection | <0,5V               |
| OT-Warning + | <0,5V               |
| OV-Detection | (OV dominates)      |
| OT-Shut-Down | <0,5V               |

#### 5.6 Over-voltage detection input (VDET)

The integrated active clamp control level can be programmed on the VDET input with the resistor devider R1, R2 (Figure 7). After fixing R1, R2 can be calculated with the following equation:

$$R_2 = \frac{R_1}{\frac{V_{clamp1}}{V_{DET+1}} - 1}$$

V<sub>Clamp</sub> = programmed clamping level

 $V_{DET+1}$  = internal  $V_{DET+1}$  threshold

When the voltage at VDET goes above the internal threshold of  $V_{DET1+}$ , the Active Clamp Control (ACC) takes over and turns on the IGBT in order to regulate the voltage at VDET to  $V_{DET+1}$  and therefore the collector voltage to the programmed level  $V_{Clamp1}$ . After the time  $T_{clamp1}$  the internal clamping level is increased by 11%. The ACC stay's active until the voltage at VDET drops below  $V_{DET1+}$  within  $T_{clamp1}$  or below  $V_{DET2+}$  after  $T_{clamp1}$ . A third internal threshold at  $V_{DET}$  ( $V_{RST-}$ ) takes care, that the IGBT is not turned on at a too high voltage level. Therefore the driver stay's disabled until the VDET voltage drops below  $V_{RST-}$ . The restart level ( $V_{RST-}$ ) can be calculated with following equation:

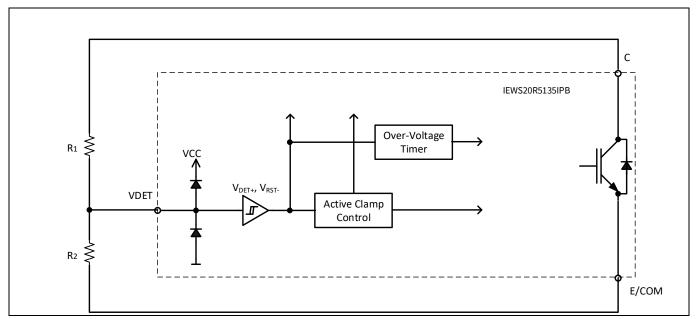
$$V_{RST} = V_{clamp1} * \frac{V_{RST-}}{V_{DET+1}}$$

In normal operation the  $V_{RST-}$  threshold is also active and blocks the turn-on of the IGBT until the VDET voltage falls below  $V_{RST-}$ , but the INN is not switched to GND compared to the OV-detection mode (Table 15). If the INN is switched to GND from the control system when the  $V_{CE}$ > $V_{RST-}$  the complete cycle is skipped (see Figure 9).



#### Pin Configuration, Description and Functionality

For short clamp situations, which can occur for example when the vessel is removed from the cooking surface, an over-voltage timer (OVT) is triggered in parallel. The OVT disables the driver for the over-voltage blank time so that the connected microcontroller has time to recognize and to react on the situation.





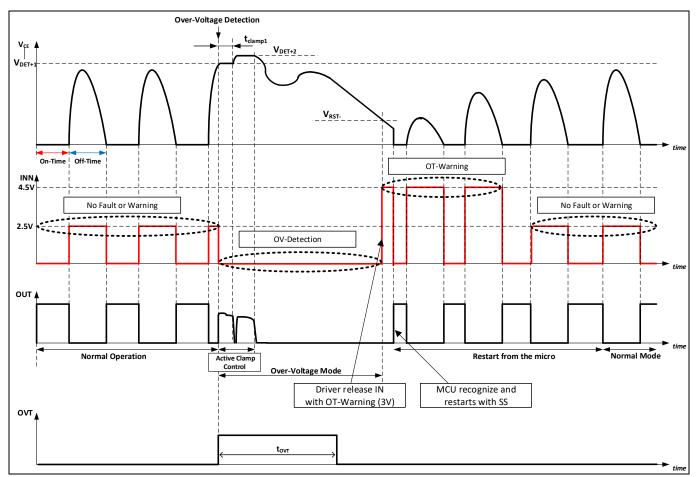


Figure 8 Active Clamp Control timing & Diagnostic



Pin Configuration, Description and Functionality

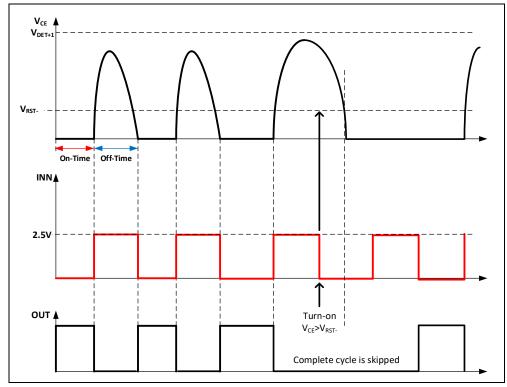


Figure 9 Function turn-on, if V<sub>CE</sub>>V<sub>RST</sub>.

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**Timing Diagrams** 

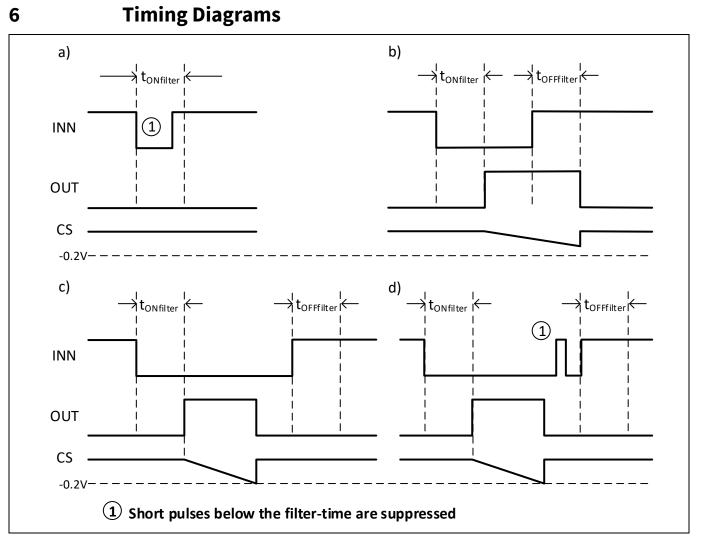


Figure 10 Input Noise Filter

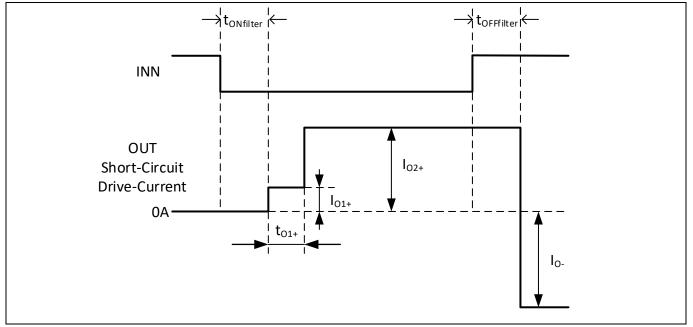
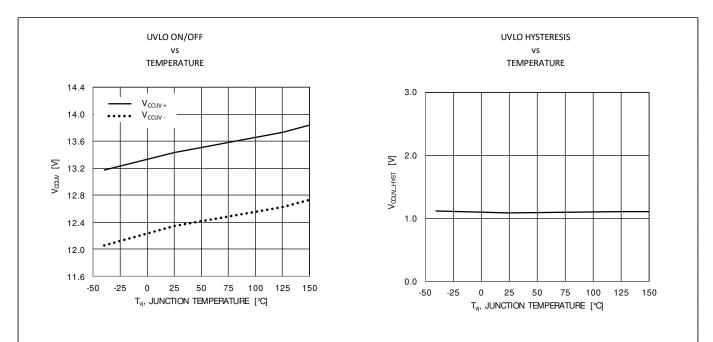


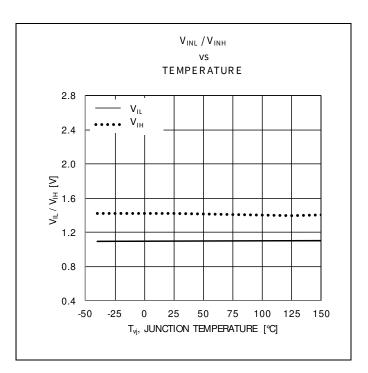
Figure 11 OUT Short-Circuit Drive-Current



7 Electrical Characteristics Diagrams

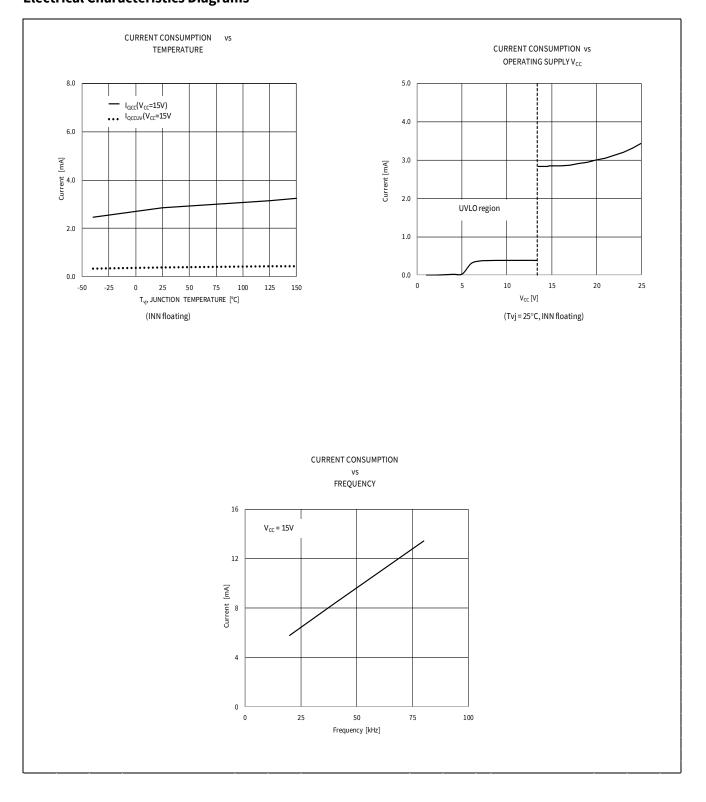


# Figure 12. Undervoltage Lockout

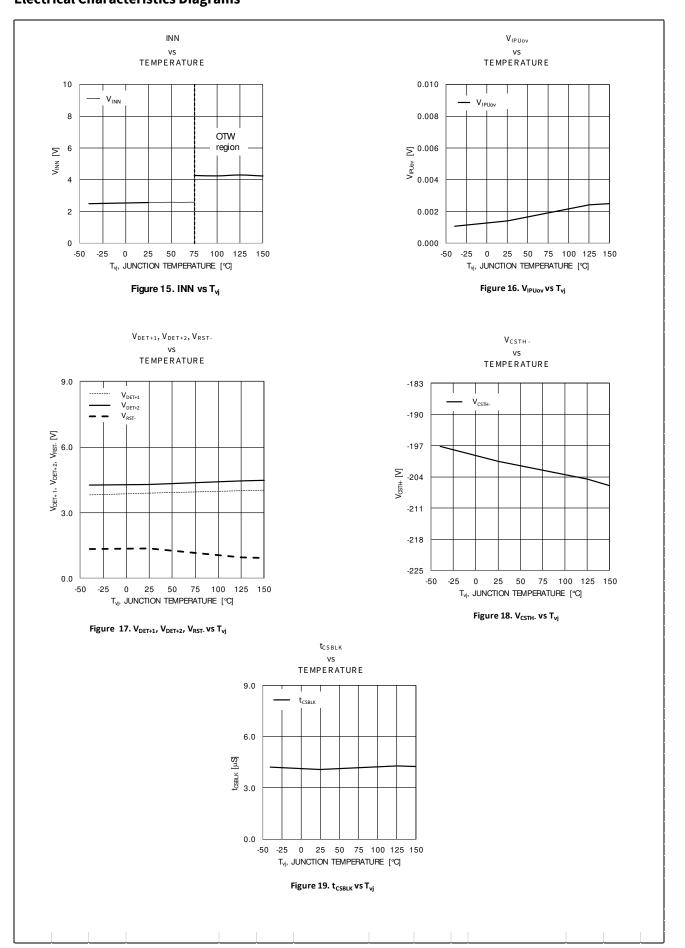














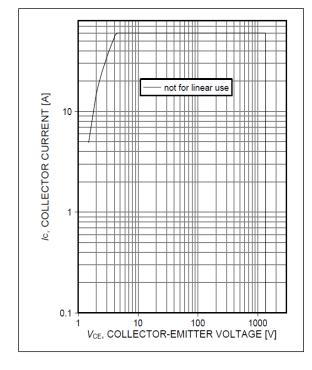
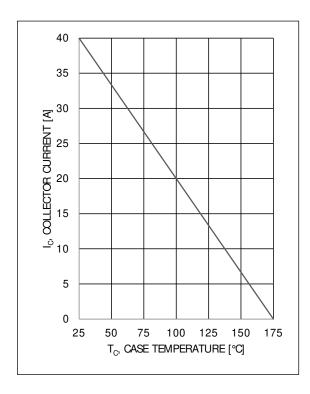
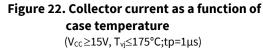


Figure 20. Safe operating area  $(D=0, T_c=25^{\circ}C, T_{vj}=175^{\circ}C; V_{cc}=15V, t_p=1\mu s)$ 





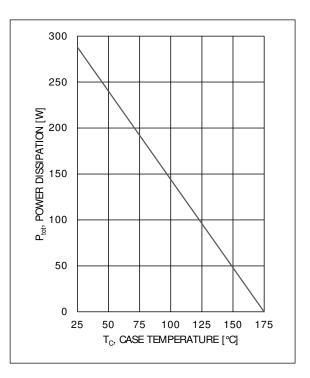


Figure 21. Power dissipation as a function of case temperature  $(T_{vj} \leq 175^{\circ}C)$ 

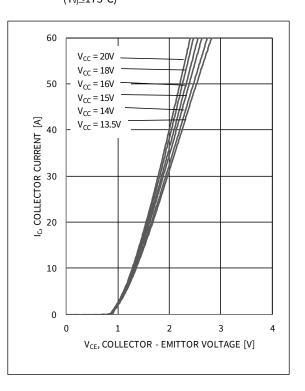


Figure 23. Typical output characteristic  $(T_{vj}=25^{\circ}C)$ 



#### **Electrical Characteristics Diagrams**

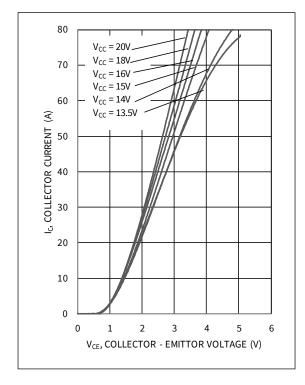
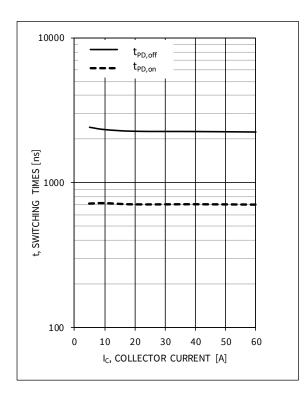


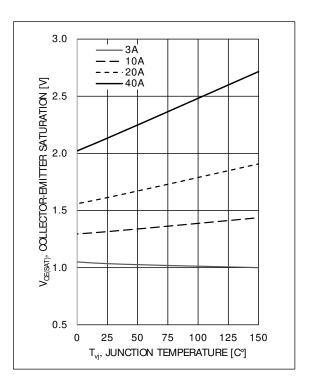
Figure 24. Typical output characteristic

(T<sub>vi</sub>=150°C)

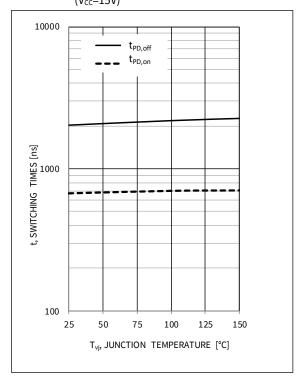


#### Figure 26. Typical switching times as a function of collector current

(inductive load,  $T_{vj}$ =150°C,  $V_{CE}$ =600V,  $V_{CC}$ = 15, dynamic test circuit in Figure F)



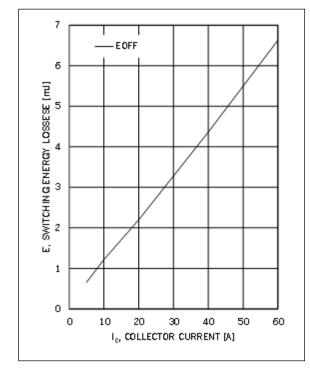
#### Figure 25. Typical collector-emitter saturation voltage as a function of junction temperature (V<sub>cc</sub>=15V)



#### Figure 27. Typical switching times as a function of junction temperature

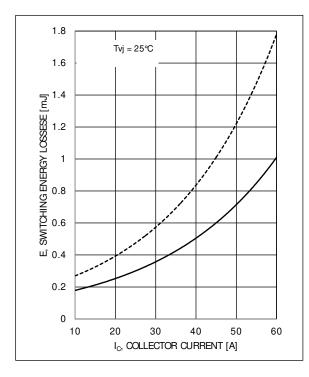
(inductive load, V<sub>CE</sub>=600V, V<sub>CC</sub>= 15V, I<sub>C</sub>=20A, Dynamic test circuit in Figure F)





# Figure 28. Typical switching energy losses as a function of collector current (inductive load, T<sub>vj</sub>=150°C,V<sub>CE</sub>=600V,

V<sub>cc</sub>=15V, Dynamic test circuit in Figure F)



# Figure 30. Typical turn off switching energy loss for soft switching

(Inductive load,Vc=600V, Vcc=15V, Dynamic test circuit in Figure F)

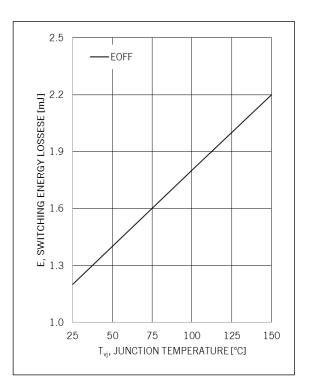


Figure 29. Typical switching energy losses as a function of junction temperature (inductive load,V<sub>CE</sub>=600V, V<sub>CC</sub>=15V, I<sub>c</sub>=20A, Dynamic test circuit in Figure F)

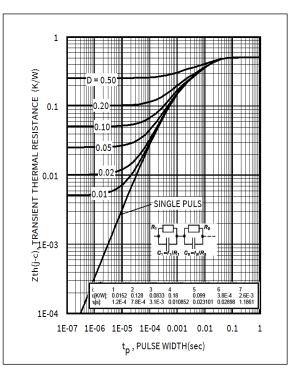


Figure 31. IGBT transient thermal impedance  $(D=t_p/T)$ 



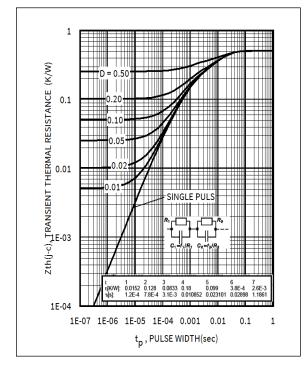


Figure 32. Diode transient thermal impedance as a function of pulse width

 $(D=t_p/T)$ 

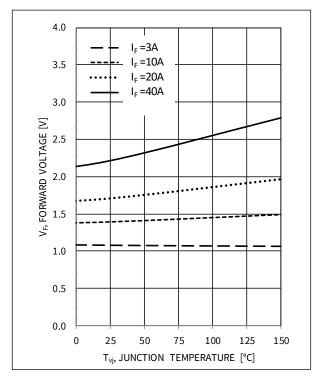


Figure 34. Typical diode forward voltage as a function of junction temperature

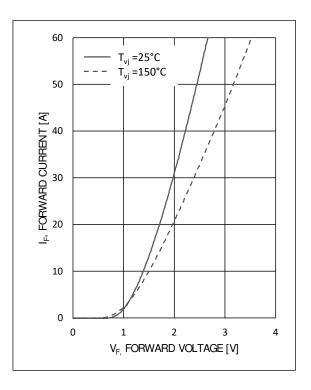


Figure 33. Typical diode forward current as a function of forward voltage



8 Test Conditions

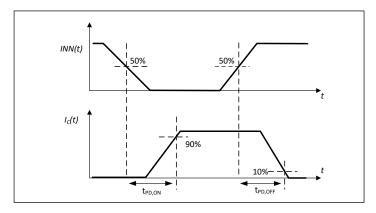


Figure A. Definition of switching times

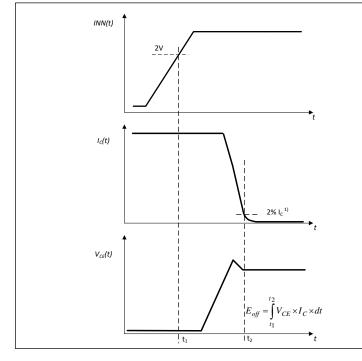


Figure B. Definition of switching losses

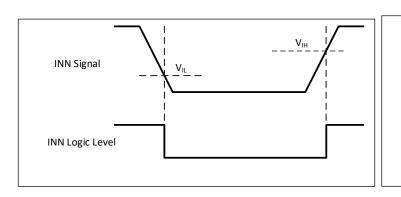
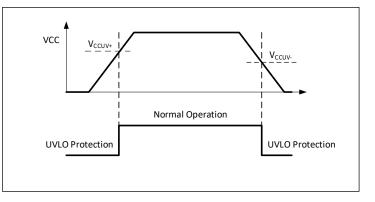
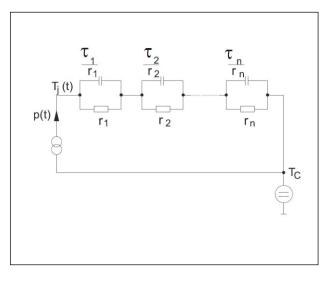


Figure C. INN Thresholds

 $^1$  For soft switching is 1% Ic.



**Figure D. UVLO Protection** 





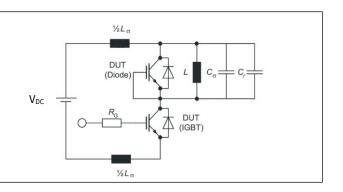


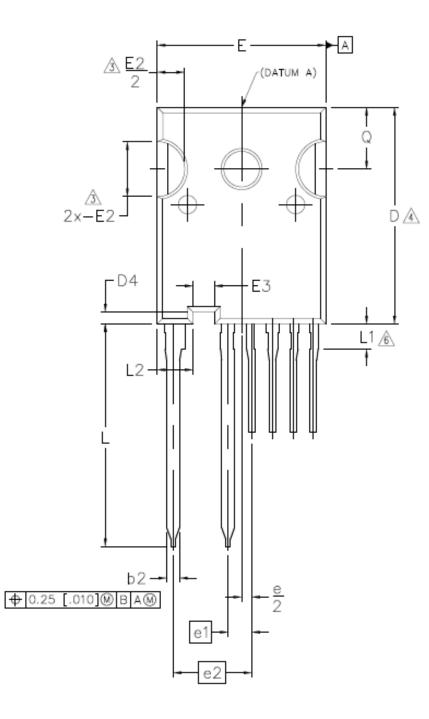
Figure F. Dynamic test circuit

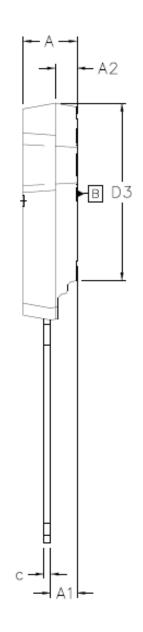


9 Pa

Package Drawing

PG-TO247-6







#### 9.1 Package Dimensions

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M 1994.
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS
- 3. CONTOUR OF SLOT OPTIONAL.
- DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 [.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
- 5. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSIONS D1 & E1.
- ∠6∆ LEAD FINISH UNCONTROLLED IN L1.
- ØP TO HAVE A MAXIMUM DRAFT ANGLE OF 1.5 ' TO THE TOP OF THE PART WITH A MAXIMUM HOLE DIAMETER OF .154 INCH.
- 8. A1 MEASUREMENT IS LOCATED AT 2.33 MM FROM THE PACKAGE EDGE.

|        | DIMENSIONS  |       |        |      |       |
|--------|-------------|-------|--------|------|-------|
| SYMBOL | MILLIMETERS |       | INCHES |      |       |
|        | MIN.        | MAX.  | MIN.   | MAX. | NOTES |
| Α      | 4.65        | 5.31  | .183   | .209 |       |
| A1     | 2.15        | 2.70  | .085   | .106 | 8     |
| A2     | 1.50        | 2.50  | .059   | .098 |       |
| ь      | 0.45        | 0.80  | .018   | .031 |       |
| b2     | 0.90        | 1.50  | .035   | .059 |       |
| с      | 0.45        | 0.90  | .018   | .035 |       |
| D      | 19.70       | 20.70 | .776   | .815 | 4     |
| D1     | 12.20       | -     | .480   | -    | 5     |
| D2     | 1.00        | 1.80  | .040   | .071 |       |
| D3     | 16.00       | 17.00 | .630   | .670 |       |
| D4     | 0.90        | 1.30  | .035   | .051 | 4     |
| E      | 15.30       | 15.90 | .602   | .626 | 4     |
| E1     | 12.20       | -     | .480   | -    | 5     |
| E2     | 4.70        | 5.50  | .185   | .216 |       |
| E3     | 1.80        | 2.20  | .071   | .087 | 4     |
| е      | 1.90        | BSC   | .075   | BSC  |       |
| e1     | 2.20        | BSC   | .087   | BSC  |       |
| e2     | 7.28        | BSC   | .287   | BSC  |       |
| øk     |             | 25    | .010   |      |       |
| L      | 19.80       | 21.00 | .780   | .827 |       |
| L1     | 2.03        | 2.64  | .080   | .104 | 6     |
| L2     | 3.00        | 3.60  | .118   | .142 | 4     |
| L4     | 9.40        | 10.60 | .370   | .417 |       |
| øР     | 3.48        | 3.76  | .137   | .148 | 4     |
| ØP1    | -           | 7.39  | -      | .291 |       |
| Q      | 5.40        | 6.20  | .212   | .244 |       |
| S      | 5.72        | BSC   | .225   | BSC  |       |



# **Revision History**

## Revision: 2020-01-22, Rev.2.2

| Revision | Date       | Subjects (major changes since last revision)                     |  |
|----------|------------|--|--|
| 2.0      | 2018-06-28 | Final Datasheet  |  |
| 2.1      | 28-05-2019 | Revised version  |  |
| 2.2      | 22-01-2020 | Product name change  |  |
| 2.3      | 24-04-2020 | Correction of acronym 'IPD' in page 1, correction of minor typos |  |

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